

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YI CHEN	01/25/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SHENZHEN HONGYUHAO TRADING CO., LTD.
<b>Street Address:</b>	ROOM 601, BUILDING B, FLOOR 6, NO. 568-4, BULONG ROAD, YANGMEI COMMUNITY, BANTIAN STREET, LONGGANG DISTRICT
<b>City:</b>	SHENZHEN
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29768374
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	9092841648
<b>Email:</b>	pair@jumpy-ip.com,chew@jumpy-ip.com,nancy-zheng@jumpy-ip.com
<b>Correspondent Name:</b>	CHEW PATENTS GROUP (JUMPY)
<b>Address Line 1:</b>	28039 SCOTT RD
<b>Address Line 2:</b>	SUITE D-180
<b>Address Line 4:</b>	MURRIETA, CALIFORNIA 92563
<b>ATTORNEY DOCKET NUMBER:</b>	TZL3US210187
<b>NAME OF SUBMITTER:</b>	RAYMOND J. CHEW
<b>SIGNATURE:</b>	/Raymond J. Chew/
<b>DATE SIGNED:</b>	01/29/2021
<b>Total Attachments: 2</b>	
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**ASSIGNMENT**

YI CHEN having a mailing address NO. 519, GROUP 11, PENGYING, HEIZHANG VILLAGE, ZHANGLIN TN., PING COUNTY, NANYANG CITY, HENAN, CHINA (hereafter referred to as the undersigned), is the inventor of the U.S. patent application to be filed entitled:

**3D PUZZLE TOY**

The above U.S. application was assigned serial no. \_\_\_\_\_ and was filed on \_\_\_\_\_. The undersigned hereby authorizes assignee or assignee's representative to insert the Application Number and the filing date of this application if they are unknown at the time of execution of this assignment.

SHENZHEN HONGYUHAO TRADING CO., LTD. Having a place of business ROOM 601, BUILDING B, FLOOR 6, NO. 568-4, BULONG ROAD, YANGMEI COMMUNITY, BANTIAN STREET, LONGGANG DISTRICT, SHENZHEN CITY, GUANGDONG, CHINA (hereafter referred to as the assignee), is desirous of the entire right, title and interest in the above-identified application, in said invention described therein, all applications for and all letters patent issued on said invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee and assignee's successors, assigns and legal representatives the entire right, title and interest in said invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, in any subsequent nonprovisional applications filed for this invention or improvements thereto, and all divisions and continuations thereof, any Registered Community Design applications, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention

throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

The undersigned warrant that the rights and property herein conveyed are free and clear of any encumbrance. EXECUTED under seal on the following date 2021-01-25

Typed or printed name	Signature
YI CHEN	